



**PATENT**

**UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 10/647,297 Group Art Unit: 1794  
Filing Date: August 26, 2003 Examiner: Hai Vo  
Applicants: Hyun HUH et al.  
Title: POLISHING PAD CONTAINING EMBEDDED LIQUID  
MICROELEMENTS AND METHOD OF  
MANUFACTURING THE SAME  
Attorney Docket: 47881-000003/US

Customer Service Window  
Randolph Building  
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Alexandria, VA 22314  
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May 19, 2008

**SUPPLEMENTAL AMENDMENT UNDER 35 U.S.C. §1.116**

Sir:

In response to the Advisory Action mailed April 11, 2008, and the Final Office Action mailed January 18, 2008, the due date having been extended one (1) month to May 18, 2008, the following remarks are respectfully submitted in connection with the above-identified application.

**Amendments to the Claims** begins on page 2 of this Amendment.

**Remarks** begin on page 5 of this Amendment.

|                    | <b>Claims remaining after<br/>Amendment</b> |   | <b>Highest number<br/>previously paid for</b> |   | <b>Present extra</b> |
|--------------------|---|---|---|---|----------------------|
| <b>Total</b>       | 14  | - | 31  | = | 0                    |
| <b>Independent</b> | 1   | - | 3   | = | 0                    |